Form PTO-1595 (Rev. 03/05) OMB No. 0651-0027 (exp. 6/30/2005) U.S. DEPARTMENT OF COMMERCE United States Patent and Trademark Office

RECORDATION FORM COVER SHEET TSM04-0367					
To the Director of the U.S. Patent and Trademark Office: Pleas	To the Director of the U.S. Patent and Trademark Office: Please record the attached documents or the new address(es) below.				
1. Name of conveying party(ies)	2. Name and address of receiving party(ies)				
Chih-Hao Wang Yen-Ping Wang Chenming Hu	Name: Taiwan Semiconductor Manufacturing Company.				
Additional name(s) of conveying party(ies) attached? Yes X No 3. Nature of conveyance/Execution Date(s):	Internal Address:				
Execution Date(s) <u>Chih-Hao Wang 2-1-2005</u> , Yen-Ping Wang, 10-31-2005, <u>Chenming Hu 2-5-2005</u> .	Street Address: <u>No. 8, Li-Hsin Rd. 6</u>				
Assignment Merger Security Agreement Change of Name	Science-Based Industrial Park				
Joint Research Agreement	City: <u>Hsin-Chu</u>				
Government Interest Assignment	State: Taiwan				
Executive Order 9424, Confirmatory License	Country: <u>ROC</u> Zip: <u>300-77</u>				
Other	Additional name(s) & address(es) attached?				
 4. Application or patent number(s): Th A. Patent Application No.(s) 11/117,153 	is document is being filed together with a new application. B. Patent No.(s)				
Additional numbers attached? Yes X, No					
5. Name and address to whom correspondence concerning document should be mailed:	6. Total number of applications and patents Involved:1				
Name <u>: Steven H. Slater</u>	7. Total fee (37 CFR 1.21(h) & 3.41) \$ 40.00				
Slater & Matsil, L.L.P.	Authorized to be charged by credit card				
Internal Address:	X Authorized to be charged to deposit account				
Street Address: <u>17950 Preston Rd.</u>	Enclosed				
Suite 1000	None required (government interest not affecting title)				
City: Dallas	8. Payment Information				
State: <u>Texas</u> Zip: <u>75252-5793</u>	a. Credit Card Last 4 Numbers				
Phone Number: <u>972-732-1001</u>	Expiration Date				
Fax Number: <u>972-732-9218</u> Email Address: <u>slater@slater-matsil.com</u>	b. Deposit Account Number <u>50-1065</u>				
	Authorized User Name Steven H. Slater				
X f					
9. Signature:	<u>November 3, 2005</u>				
Signature	Date Total number of pages including cover				
Steven H. Slater, Reg. No. 35,361 Name of Person Signing	sheet, attachments, and documents: 2				
	et) should be faxed to (703) 306-5995, or mailed to: f the USPTO, P.O. Box 1450, Alexandria, V.A., 22313-1450				

PATENT REEL: 016980 FRAME: 0315

SLATER & MATSIL LLP

P.02

31-OCT-2005 16:34

FROM

ATTORNEY DOCKET NO. TSM04-0367

ASSIGNMENT

WHEREAS, (, the undersigned inventor (or one of the undersigned joint inventors), of residence as itsted, having invented certain new and useful improvements as below entitled, for which application for United States Letters Patent is made, the said application having been executed on the date set forth below; and

WHEREAS, Teiwan Semiconductor Manufacturing Company, Ltd. (TSMC), a corporation organized and existing under the laws of Taiwan, the Republic of China, with its principal office at No. 6, Li-Hsin Rd. 6, Science-Based Industrial Park, Hsin-Chu, Taiwan 300-77, R.O.C., is desirous of acquiring my entire right, title and interest in and to the said invention, and to the said application and any Letters Patent that may issue thereon in the United States and all other countries throughout the world;

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, I hereby sell and assign to the said TSMC, its successors and assigns, my entire right, title and interest in and to the said invention and in to the said application and all patents which may be granted therefor, and all divisions, reissues, substitutions, continuations, and extensions thereof; and I hereby authorize and request the Commissioner for Patents to issue all patents for said invention, or patent resulting therefrom, insofar as my interest is condamed, to the said TSMC, as assignee of my entire right, title and interest, I declare that I have not executed and will not execute any agreement in conflict herewith.

I also hereby sell and assign to TSMC, its successors and assigns, my foreign rights to the invention disclosed in said application, in all countries of the world, including, but not limited to, the right to file applications and obtein palents under the terms of the International Convention for the Protection of Industrial Property, and of the European Patent Convention, and further agree to execute any and all patent applications, assignments, affidavits. and any other papers in connection therewith necessary to perfect such patent rights.

I hereby further egree that I will communicate to said TSMC, or to its successors, assigns, and legal representatives, any facts known to me respecting said invention or the file history thereof, and at the expense of said assignee company, testify in any legal proceedings, sign all lawful papers, execute all divisional, continuation, reissue and substitute applications, make all lawful oaths, and generally do everything possible to aid said TSMC, its successors, assigns and nominees to obtain and enforce proper patent protection for said invention in all countries.

TITLE OF <u>INVENTION</u>	Partial Replacement Silicide Gate			· · · · · · · · · · · · · · · · · · ·
SIGNATURE OF INVENTOR AND NAME	Chih-Hao Wang Chih-Hao Wang	Yen-Ping Wang Yen-Ping Wang	Cheaming Hu	·····
DATE	Feb. 1, 2005	1=/31/2005	2/5/2005	
RESIDENCE (City, County, State)	Hsin-Chu, Taiwan R.O.C.	Teipei, Teiwan R.O.C.	Aiamo, CA US	· · · · · · · · · · · · · · · · · · ·

IN WITNESS WHEREOF. I hereunto set my hand and seal this day and year;

TSM04-0367

Assignment

PATENT REEL: 016980 FRAME: 0316

RECORDED: 11/03/2005